



# Product Change Notification

**Change Notification #:** 115473 - 00  
**Change Title:** Intel® Dual Band Wireless-AC 3160 SKUs:  
3160.HMWG, 3160.HMWG.R  
3160.HMWGBR, 3160.HMWWB.R,  
3160.NGWG, 3160.NGWG.B,  
3160.NGWG.R, 3160.NGWGBR,  
3160.NGWWB.R,  
PCN 115473-00, Label,  
Label Update  
**Date of Publication:** April 26, 2017

**Key Characteristics of the Change:**  
Label

## Forecasted Key Milestones:

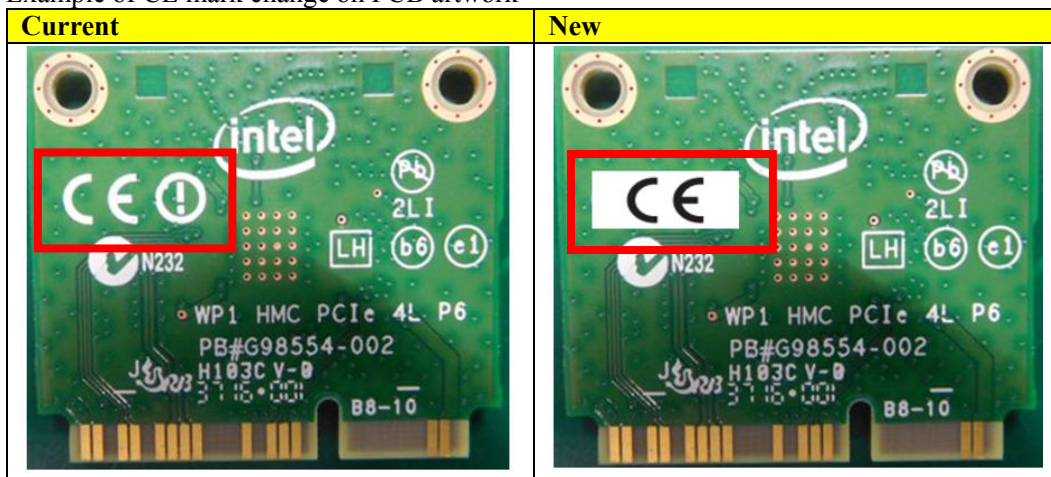
<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	May 12, 2017
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## Description of Change to the Customer:

As a result of changes decreed by the new European Radio Equipment Directive 2014/53/EU. Intel is making the following updates to the Intel® Dual Band Wireless-AC 3160 SKUs listed in the products affected table below.

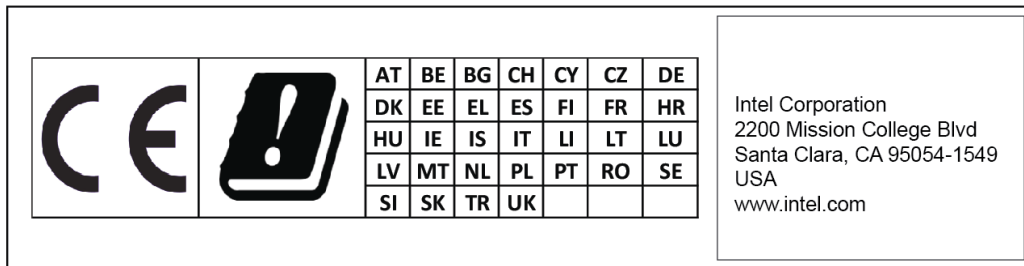
1. The current CE ! Mark on the module will be modified to remove the Alert Symbol (!) following the CE mark.

Example of CE mark change on PCB artwork



We will be adding 2 graphics to the outer packaging to be visible by EU customs.

- a. A new CE graphic:
- b. The Intel Corporate address



The Artwork for outer packaging has not been finalized by the EU at this time. As a result Intel may need to initiate these out packaging additions in 2 phases.

**Phase 1:** separate labels will be created and added to the side of the outer box.

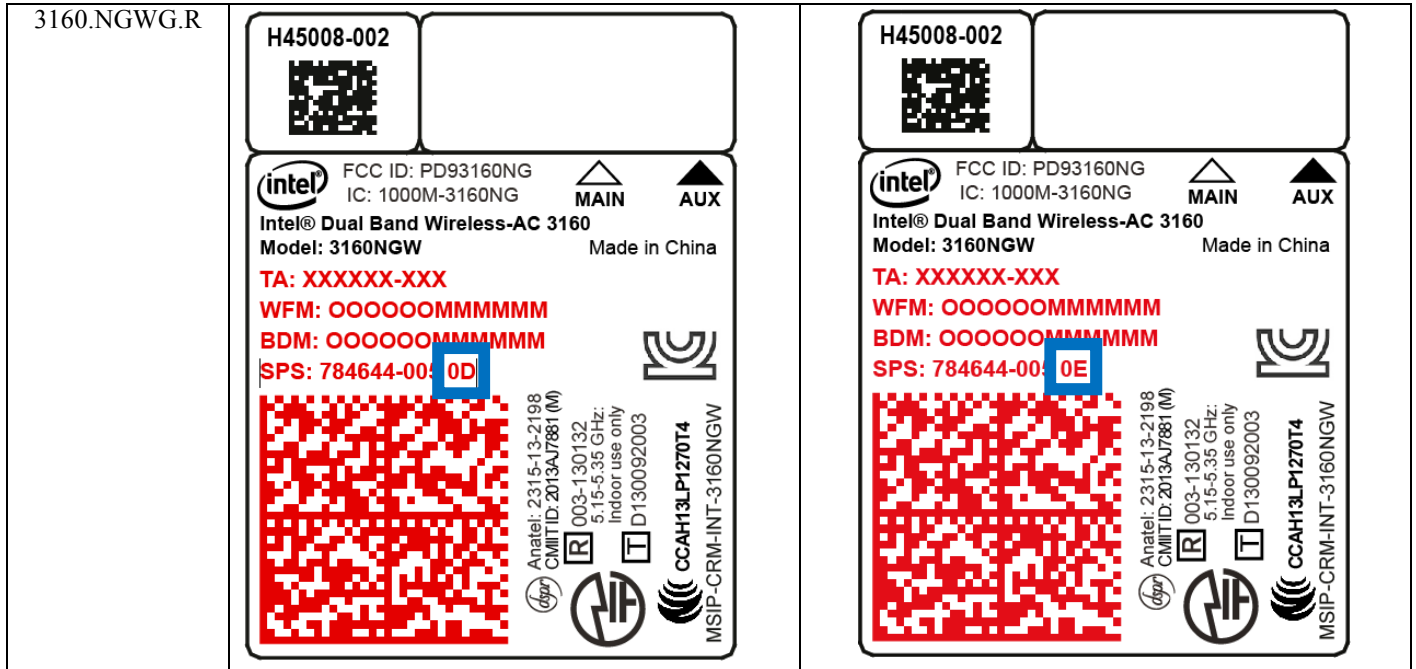
**Phase 2:** Intel will incorporate into the existing out box labels.

- Intel is updating an internal revision number on the Label for the following SKU's:

SKU	Before	After
3160.HMWG	0F	0G
3160.HMWG.R	0D	0E
3160.HMWGBR	0D	0E
3160.NGWG	0E	0F
3160.NGWG.B	0A	0B
3160.NGWG.R	0D	0E



<p>3160.HMWGBR</p>	<p>H26796-003</p>  <p>intel Made in Brazil</p> <p>MAIN ▲ AUX ▲</p> <p>Intel® Dual Band Wireless-AC 3160 FCC ID: PD93160H Model: 3160HMW CMIIT ID: 2013AJ7882 (M) IC: 1000M-3160H</p> <p>WFM: OOOOOOMMMMMM BDM: OOOOOOMMMMMM TA: XXXXXX-XXX SPS: 710662-00 <b>0D</b></p> <p>Anatel: 2316-13-2198 CMIIT ID: 2013AJ7881 (M) 003-130132 5.15-5.35 GHz: Indoor use only D130091003</p> 	<p>H26796-003</p>  <p>intel Made in Brazil</p> <p>MAIN ▲ AUX ▲</p> <p>Intel® Dual Band Wireless-AC 3160 FCC ID: PD93160H Model: 3160HMW CMIIT ID: 2013AJ7882 (M) IC: 1000M-3160H</p> <p>WFM: OOOOOOMMMMMM BDM: OOOOOOMMMMMM TA: XXXXXX-XXX SPS: 710662-00 <b>0E</b></p> <p>Anatel: 2316-13-2198 CMIIT ID: 2013AJ7881 (M) 003-130132 5.15-5.35 GHz: Indoor use only D130091003</p> 
<p>3160.NGWG</p>	<p>H11872-004</p>  <p>intel FCC ID: PD93160NG IC: 1000M-3160NG</p> <p>MAIN ▲ AUX ▲</p> <p>Intel® Dual Band Wireless-AC 3160 Model: 3160NGW Made in China</p> <p>TA: XXXXXX-XXX WFM: OOOOOOMMMMMM BDM: OOOOOOMMMMMM SPS: 751416-00 <b>0E</b></p> <p>Anatel: 2315-13-2198 CMIIT ID: 2013AJ7881 (M) 003-130132 5.15-5.35 GHz: Indoor use only D130092003</p> 	<p>H11872-004</p>  <p>intel FCC ID: PD93160NG IC: 1000M-3160NG</p> <p>MAIN ▲ AUX ▲</p> <p>Intel® Dual Band Wireless-AC 3160 Model: 3160NGW Made in China</p> <p>TA: XXXXXX-XXX WFM: OOOOOOMMMMMM BDM: OOOOOOMMMMMM SPS: 751416-00 <b>0F</b></p> <p>Anatel: 2315-13-2198 CMIIT ID: 2013AJ7881 (M) 003-130132 5.15-5.35 GHz: Indoor use only D130092003</p> 
<p>3160.NGWG.B</p>	<p>H73452-002</p>  <p>intel FCC ID: PD93160NG IC: 1000M-3160NG</p> <p>MAIN ▲ AUX ▲</p> <p>Intel® Dual Band Wireless-AC 3160 Model: 3160NGW Made in Brazil</p> <p>TA: XXXXXX-XXX WFM: OOOOOOMMMMMM BDM: OOOOOOMMMMMM SPS: 751416-20 <b>0A</b></p> <p>Anatel: 2315-13-2198 CMIIT ID: 2013AJ7881 (M) 003-130132 5.15-5.35 GHz: Indoor use only D130092003</p> 	<p>H73452-002</p>  <p>intel FCC ID: PD93160NG IC: 1000M-3160NG</p> <p>MAIN ▲ AUX ▲</p> <p>Intel® Dual Band Wireless-AC 3160 Model: 3160NGW Made in Brazil</p> <p>TA: XXXXXX-XXX WFM: OOOOOOMMMMMM BDM: OOOOOOMMMMMM SPS: 751416-20 <b>0B</b></p> <p>Anatel: 2315-13-2198 CMIIT ID: 2013AJ7881 (M) 003-130132 5.15-5.35 GHz: Indoor use only D130092003</p> 



### Customer Impact of Change and Recommended Action:

The label change does not affect the functionality of the product. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

### Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
3160.HMWG	923263	H14634-006	H14634-007
3160.NGWG	923265	H14636-007	H14636-008
3160.HMWGBR	932963	H26793-005	H26793-006
3160.HMWG.R	936208	H45005-005	H45005-006
3160.NGWG.R	936209	H45012-005	H45012-006
3160.NGWGBR	936786	H45026-002	H45026-003
3160.NGWG.B	937222	H73448-002	H73448-003
3160.HMWWB.R	937299	H54442-004	H54442-005
3160.NGWWB.R	937300	H54443-004	H54443-005

### PCN Revision History:

**Date of Revision:**

April 26, 2017

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

## 115473 - 00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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